

Docket No: Q88153

Koji WATANABE, et al.

In re application of

Appln. No.: 10/541,586 Group Art Unit: 1734

Confirmation No.: 1996 Examiner: Not yet assigned

Filed: July 7, 2005 September 30, 2005

For: CURING RESIN COMPOSITION, ADHESIVE EPOXY RESIN PASTE, ADHESIVE EPOXY RESIN SHEET, CONDUCTIVE CONNECTION PASTE, CONDUCTIVE

CONNECTION SHEET, AND ELECTRONIC COMPONENT JOINED BODY

## <u>UNDER 37 C.F.R. §§ 1.97 and 1.98</u>

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

In accordance with the duty of disclosure under 37 C.F.R. § 1.56, Applicant hereby notifies the U.S. Patent and Trademark Office of the documents which are listed on the attached PTO/SB/08 A & B (modified) form and/or listed herein and which the Examiner may deem material to patentability of the claims of the above-identified application.

One copy of each of the listed documents is submitted herewith, other than any U.S. patents and patent publications. Copies of the five (5) documents that were cited in the International Search Report (ISR) and identified in the Information Disclosure Statement filed on July 7, 2005 are attached, together with an English language abstract of each, for the Examiner's convenience.

INFORMATION DISCLOSURE STATEMENT

U.S. Appln. No.: 10/541,586

The present Information Disclosure Statement is being filed before the mailing date of

the first Office Action on the merits, and therefore no Statement under 37 C.F.R. § 1.97(e) or fee

under 37 C.F.R. § 1.17(p) is required.

In compliance with the concise explanation requirement under 37 C.F.R. § 1.98(a)(3) and

MPEP 609 for foreign language documents, Applicants note that JP 3342703 (corresponding

USP 6,328,844), JP 3114162, JP 7-73066 (corresponding GB 2 280 524 and USP 5,940,603),

and JP 2002-313143 are discussed on pages 3, 5, and 6 of the specification, and a corresponding

English language abstract thereof is also enclosed herewith.

The submission of the listed documents is not intended as an admission that any such

document constitutes prior art against the claims of the present application. Applicant does not

waive any right to take any action that would be appropriate to antedate or otherwise remove any

listed document as a competent reference against the claims of the present application.

The USPTO is directed and authorized to charge all required fees, except for the Issue

Fee and the Publication Fee, to Deposit Account No. 19-4880. Please also credit any

overpayments to said Deposit Account. A duplicate copy of this paper is attached.

Respectfully submitted,

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WASHINGTON OFFICE

23373

CUSTOMER NUMBER

Date: September 30, 2005

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Substitute for Form 1449 A & B/PTO		Complete if Known		
Substitute for Form 1449 A & B/t 10			Application Number	10/541,586
INFO	RMATION I	DISCLOSURED E	Confirmation Number	1996
STAT	EMENT BY	APPLICANT	Filing Date	July 7, 2005
			N First Named Inventor	Koji WATANABE
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(use as many sheets as necessary) SEP 9 0 2005			Examiner Name	Not yet assigned
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****	U.S. PATENT DOCUMENTS					
Examiner Cit Initials* No	Cita	Document Number		Publication Date		
	No.1	Number	Kind Code <sup>2</sup> (if known)	MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	
		US 6,328,844	B1	12-11-2001	Watanabe et al	
		US 5,940,306		08-17-1999	Huang	
	***	US				
		US				
		US				
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FOREIGN PATENT DOCUMENTS							
Examiner Cite Initials* No.1	Foreign Patent Document			Publication Date	Name of Patentee or		
	Country Code <sup>3</sup>	Number <sup>4</sup>	Kind Code <sup>5</sup> (if known)	MM-DD-YYYY	Applicant of Cited Document	Translation <sup>6</sup>	
		JР	3342703		08-23-2002	HITACHI CHEMICAL CO., LTD.	w. Abstract
		JР	3114162		09-29-2000	SONY CHEMICALS	w/ Abstract
		JР	7-73066		03-17-1995	PIE DESIGN SYSTEMS INC	w/ Abstract
		GB	2 280 524	A	02-01-1995	PIE DESIGN SYSTEMS INC	
		JР	2002-313143		10-25-2002	SEKISUI CHEMICAL CO., LTD.	w/ Abstract

NON PATENT LITERATURE DOCUMENTS					
Examiner Initials*					

Examiner Signature	 Date Co	onsidered	

<sup>\*</sup>EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

<sup>&</sup>lt;sup>1</sup>Applicant's unique citation designation number (optional). <sup>2</sup>See Kind Codes of USPTO Patent Documents at www.uspto.gov, MPEP 901.04 or in the comment box of this document. <sup>3</sup> Enter Office that issued the document, by the two-letter code (WIPO Standard ST. 3). <sup>4</sup>For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. <sup>3</sup>Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST. 16 if possible. <sup>6</sup> Applicant is to indicate here if English language Translation is attached.